

REPLACEMENT SHEET
Techniques For Joining An Opto-Electronic
Module To A Semiconductor Package
Nguyen, et al.
Serial No.: 10/652,805

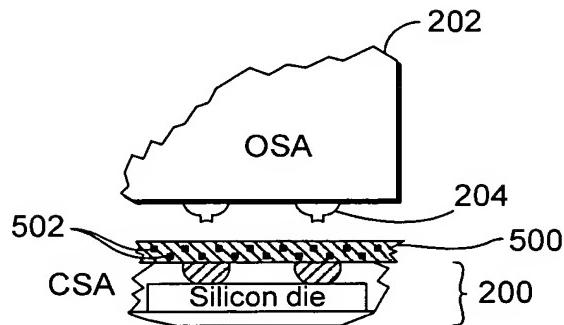


FIG. 6A

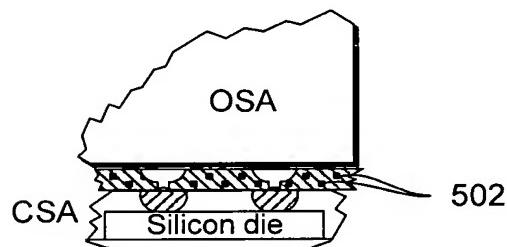


FIG. 6B

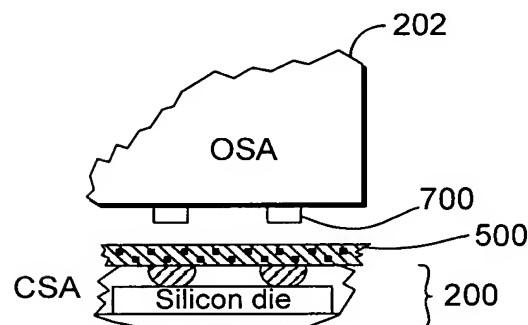


FIG. 7A

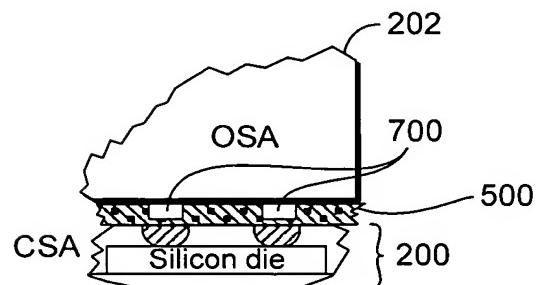


FIG. 7B

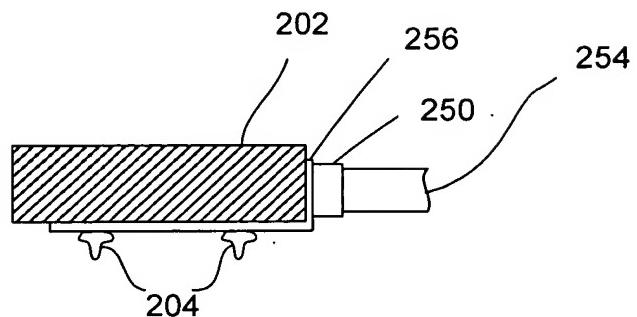


FIG. 12A

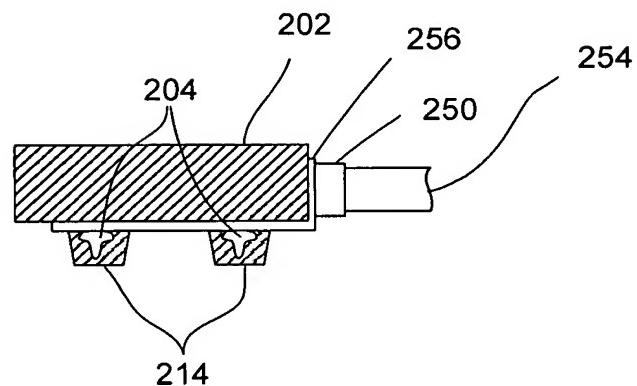


FIG. 12B

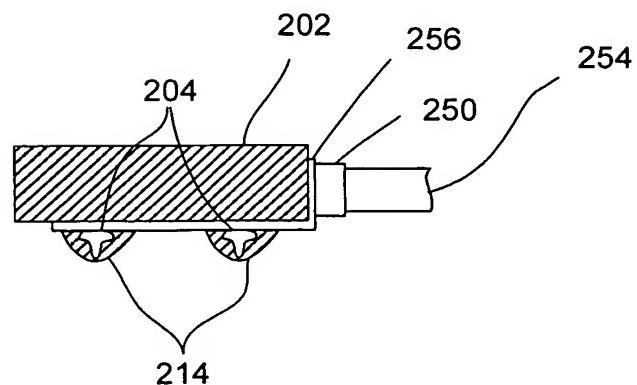


FIG. 12C

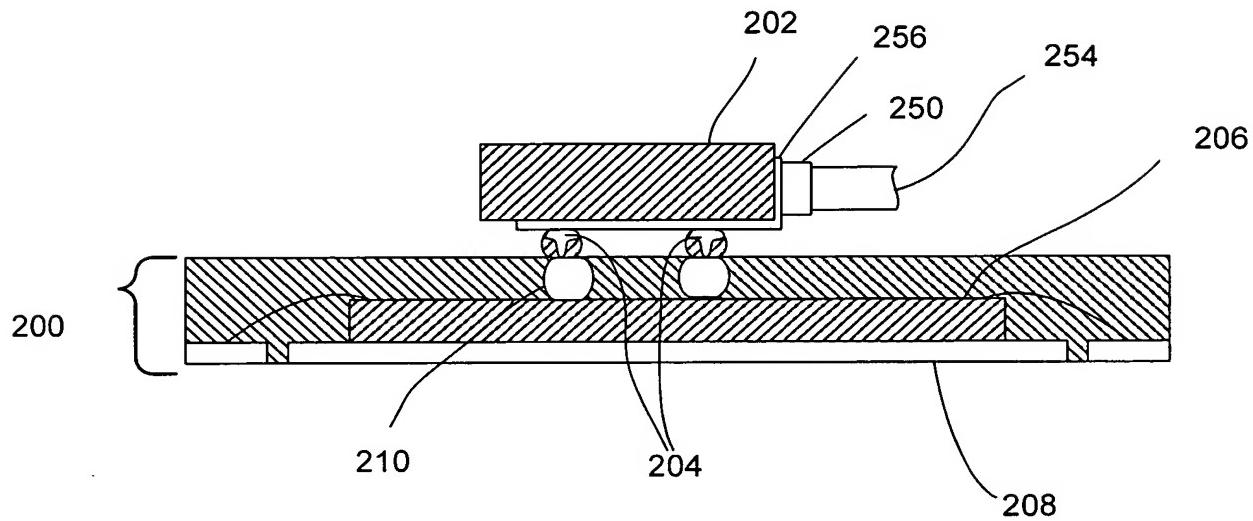


FIG. 12D

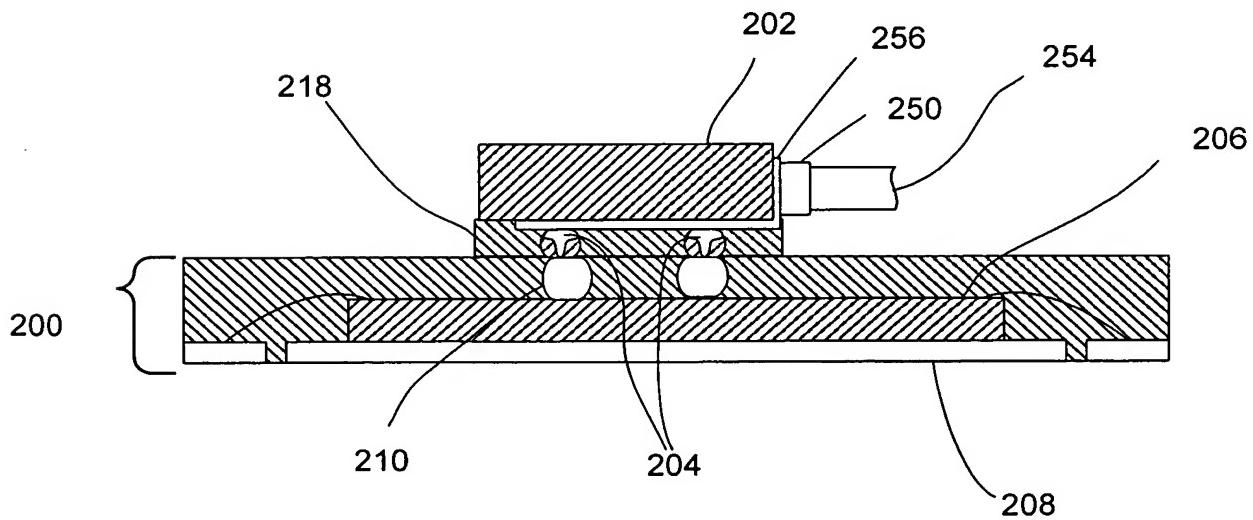


FIG. 12E